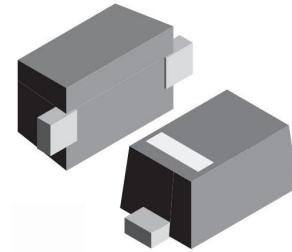


ESD3V3D5

Description

ESD3V3D5 is designed to protect voltage sensitive components from ESD and transient voltage events. Excellent clamping capability, low leakage, and fast response time, make these parts ideal for ESD protection on designs where board space is at a premium.



Features

- 200 Watts Peak Pulse Power per Line ($t_p=8/20\mu s$)
- Operating voltage: 3.3V
- Low leakage current
- Package: SOD-523
- Low clamping voltage
- Complies with following standards:
 - IEC 61000-4-2 (ESD) immunity test

Air discharge: $\pm 15kV$

Contact discharge: $\pm 8kV$

Functional Diagram



Applications

- Cellular Handsets and Accessories
- Portable Electronics
- Industrial Controls
- Set-Top Box
- Instrumentation
- Servers, Notebook, and Desktop PC
- Display Ports

Absolute Maximum Ratings(Tamb=25°C unless otherwise specified)

Parameter	Symbol	Value	Unit
Peak Pulse Power (8/20μs)	P _{PP}	200	Watts
ESD per IEC 61000-4-2 (Air)	V _{ESD}	± 15	kV
ESD per IEC 61000-4-2 (Contact)		± 8	kV
Lead Soldering Temperature	T _L	260 (10 sec)	°C
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{STJ}	-55 to +150	°C

Electrical Characteristics (TA = 25 °C unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Units
Reverse Stand-off Voltage	V _{RWM}				3.3	V
Reverse Breakdown Voltage	V _{BR}	I _t = 1mA	4			V
Reverse Leakage Current	I _R	V _R = V _{RWM}			200	µA
Clamping Voltage	V _C	I _{PP} =1A, t _P = 8/20µs			7	V
		I _{PP} =8A, t _P = 8/20µs			12	V
Junction Capacitance	C _J	V _R =0V, f = 1MHz			200	pF

Characteristics Curves

Figure 1- Power Derating Curve

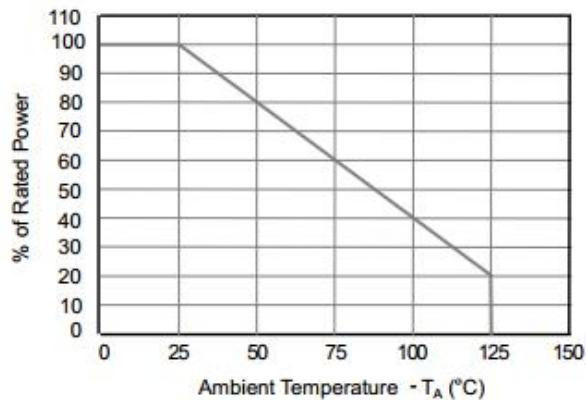
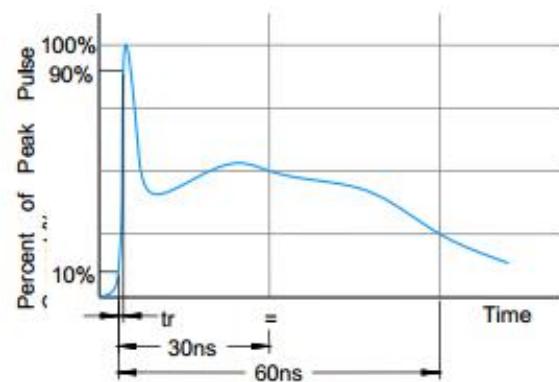
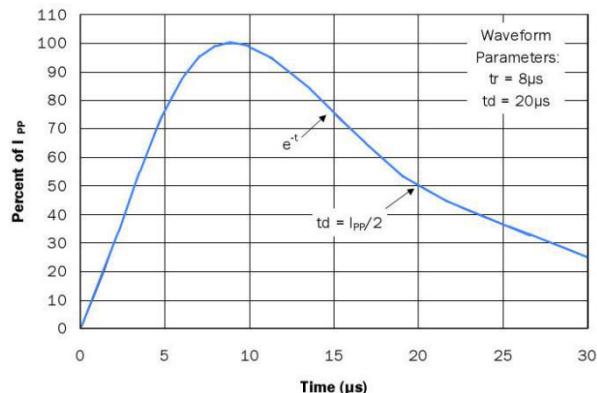
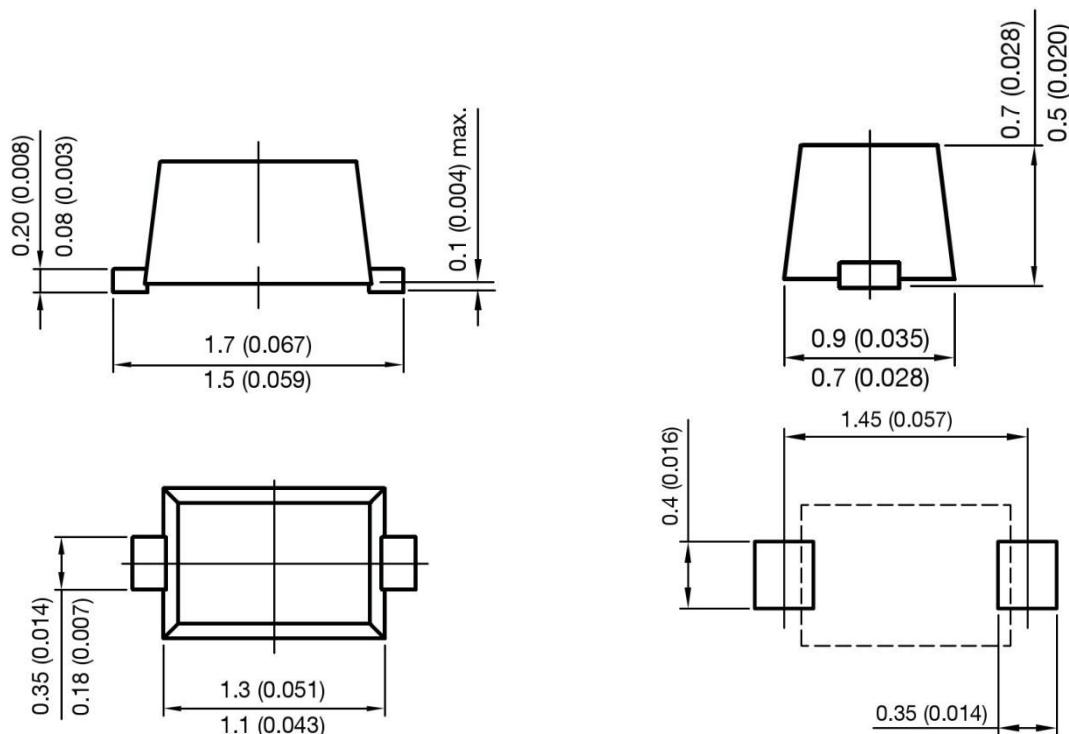

 Figure 2- ESD Pulse Waveform
(according to IEC 61000-4-2)


Figure3- 8/20 μ s Pulse Waveform


PACKAGE OUTLINE DIMENSIONS in millimeters (inches) :SOD523



Mounting Pad Layout

Disclaimer

Specifications are subject to change without notice.

The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.

Users should verify actual device performance in their specific applications.